

**General Description**

The SJD68N058 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

**Features**

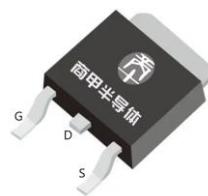
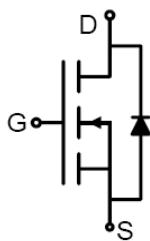
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

**Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

**Key Performance Parametes**

Parameter	Value	Unit
$V_{DS}$	68	V
$R_{DS(ON)}_{TYP}$	5.6	mΩ
$I_D$	82	A
$Q_G$	90	nC



Schematic Diagram

TO-252(DPAK) top view

**Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJD68N058	SJD68N058	TO-252	Tape	\	\	2500 Pcs

**Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	68	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_c=25^\circ\text{C}$ )	82	A
	Drain Current-Continuous( $T_c=100^\circ\text{C}$ )	52	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	328	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	94	W
	Maximum Power Dissipation( $T_c=100^\circ\text{C}$ )	38	W
$E_{AS}$	Avalanche energy (Note 2)	441	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{JC}$	Thermal Resistance, Junction-to-Case		1.33	°C/W



## 60V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	68			V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			500	nA
		$V_{\text{DS}}=68\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			500	nA
$\text{I}_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 10\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	2		4	V
$\text{g}_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$		36.5		S
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$		5.8	7	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$\text{C}_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		4724		pF
$\text{C}_{\text{oss}}$	Output Capacitance			225		pF
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance			207		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		0.73		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $R_L=1.5\Omega$ , $R_{\text{GEN}}=6\Omega$		9		nS
$t_r$	Turn-on Rise Time			7		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			40		nS
$t_f$	Turn-Off Fall Time			15		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=30\text{V}$ , $I_{\text{D}}=20\text{A}$		90		nC
$Q_{\text{gs}}$	Gate-Source Charge			10		nC
$Q_{\text{gd}}$	Gate-Drain Charge			18		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				82	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=20\text{A}$			0.99	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=20\text{A}$ , $dI/dt=100\text{A}/\text{s}$		33		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=20\text{A}$ , $dI/dt=100\text{A}/\text{s}$		46		nC

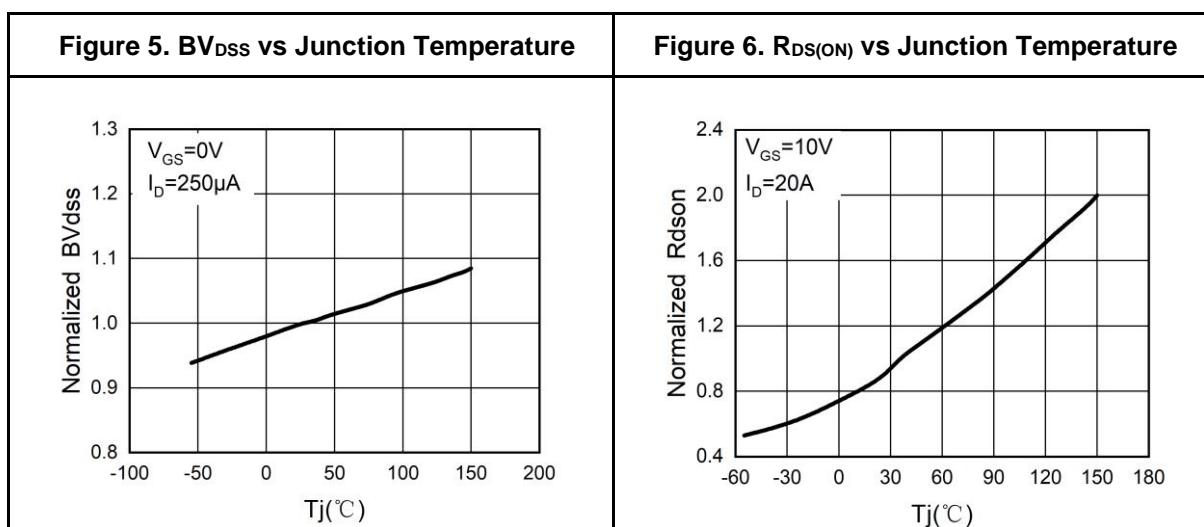
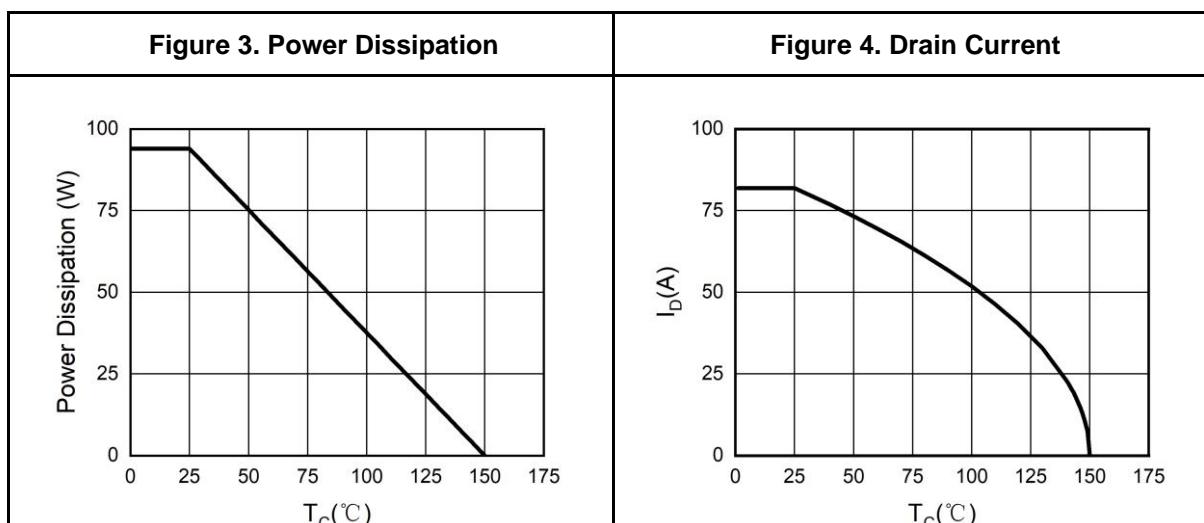
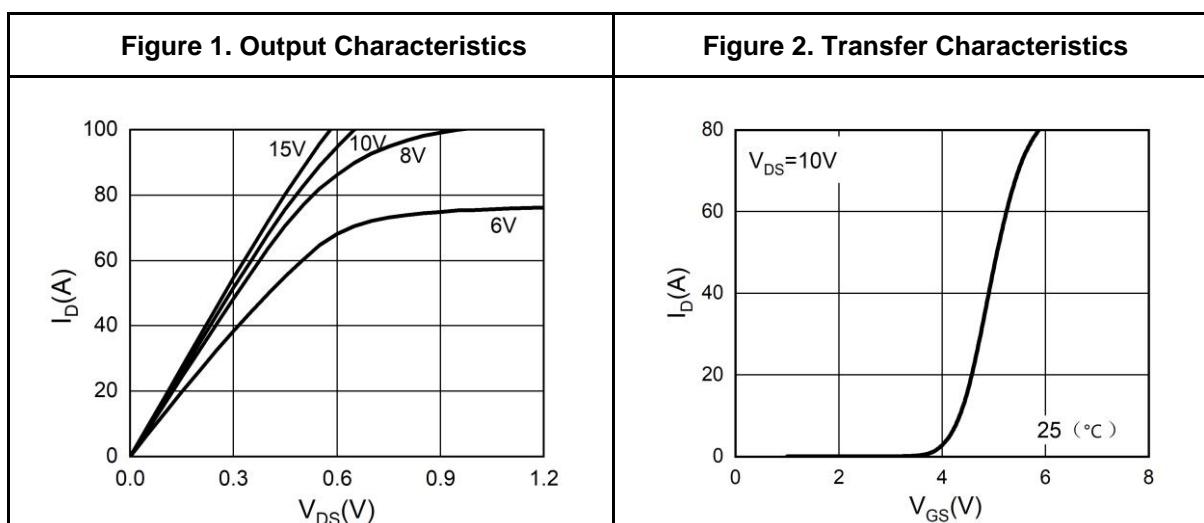
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=40\text{V}$ ,  $V_G=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

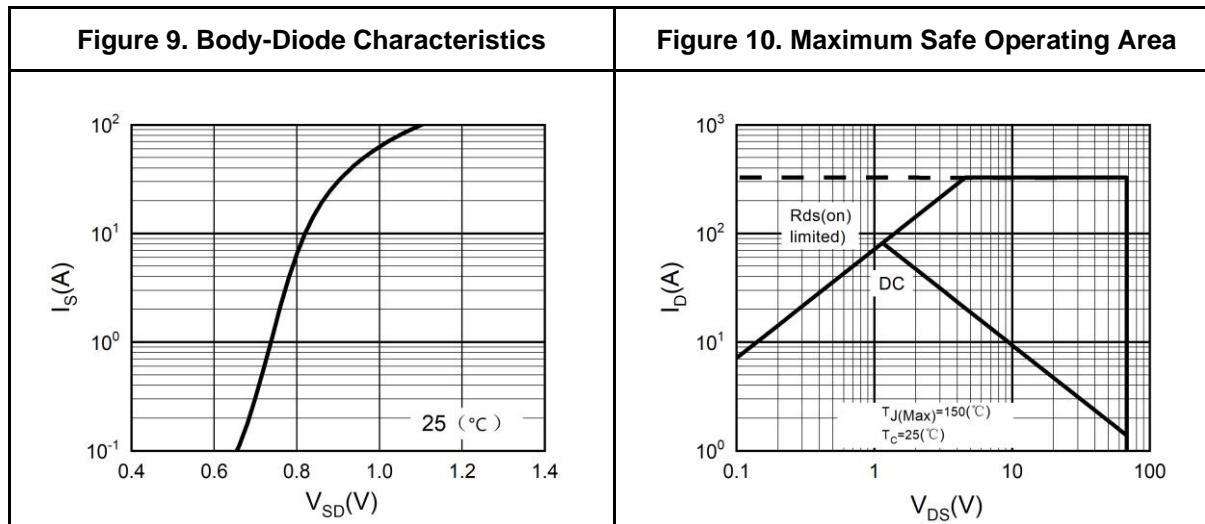
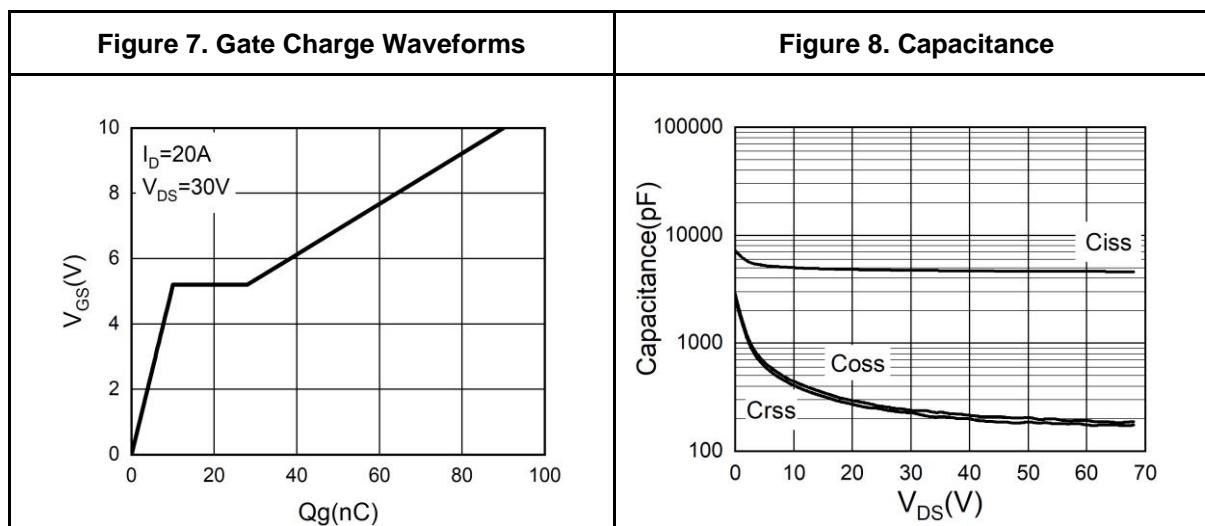


## Typical Electrical And Thermal Characteristics (Curves)



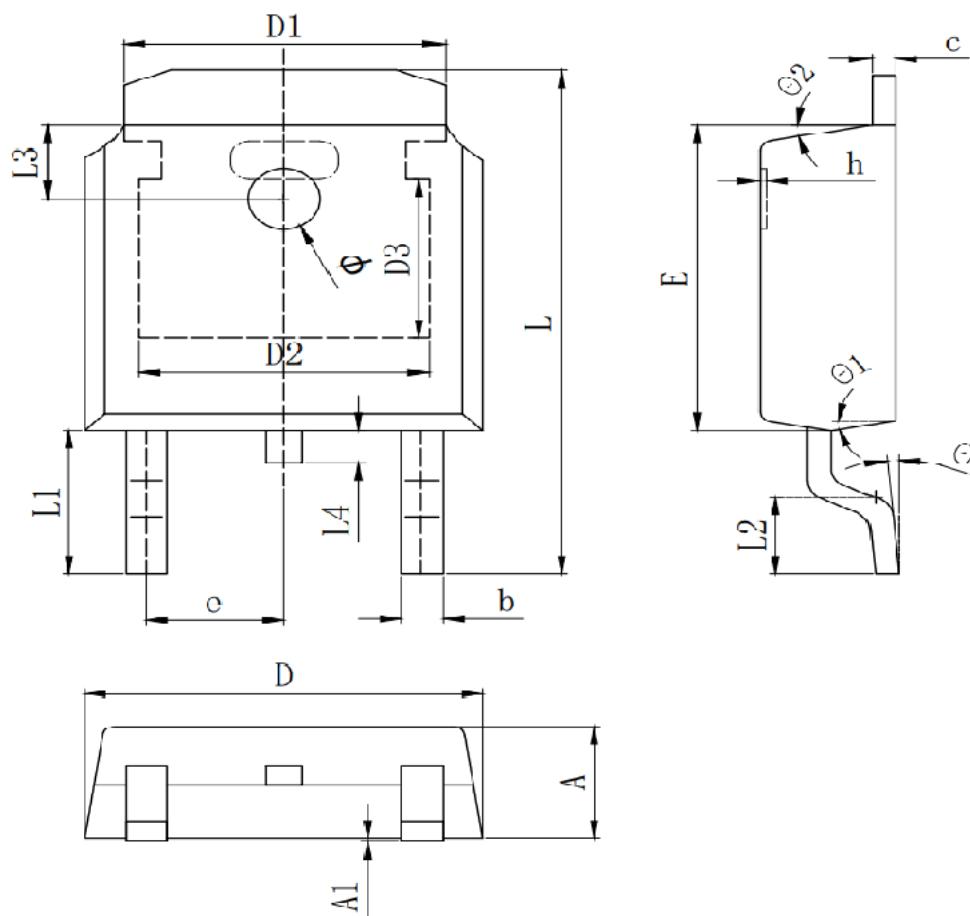


## Typical Electrical And Thermal Characteristics (Curves)





## TO-252 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1		5.334 REF	
D2		4.826 REF	
D3		3.166 REF	
E	6.000	6.100	6.200
e		2.286 TYP	
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1		2.888 REF	
L2	1.400	1.550	1.700
L3		1.600 REF	
L4	0.600	0.800	1.000
Φ	1.100	1.200	1.300
θ	0°		8°
θ1		9° TYP	
θ2		9° TYP	



## **Attention**

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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